

2814



IR-1839 (2-2729) *Half-Election KJ 6/3/03*

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Mark Pavier

Date: May 28, 2003

Serial No.: 10/045,809

Group Art Unit: 2814

Filed: January 11, 2002

Examiner: Phat X. Cao

For: A-CLIP TYPE LEAD FRAME FOR SOURCE MOUNTED DIE

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO RESTRICTION REQUIREMENT

Sir:

This is in response to the Restriction Requirement dated May 13, 2003 in which restriction between the inventions of Group I and Group II was required.

Applicant elects the invention of Group I, Claims 1-15 drawn to semiconductor device structure without traverse.

Applicant reserves the right to file a divisional application directed to the subject matter covered in the non-elected claims 16-20.

A favorable action is respectfully requested.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 28, 2003

Samuel H. Weiner
Name of applicant, assignee or
Registered Representative

Samuel H. Weiner

Signature
May 28, 2003

Date of Signature

Respectfully submitted,

Samuel H. Weiner
Registration No.: 18,510
OSTROLENK, FABER, GERB & SOFFEN, LLP
1180 Avenue of the Americas
New York, New York 10036-8403
Telephone: (212) 382-0700

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